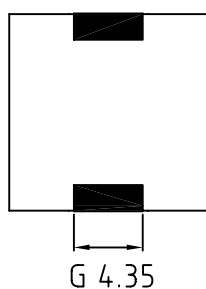
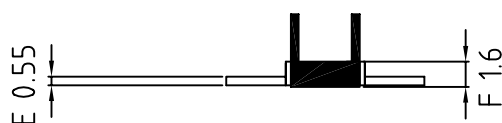
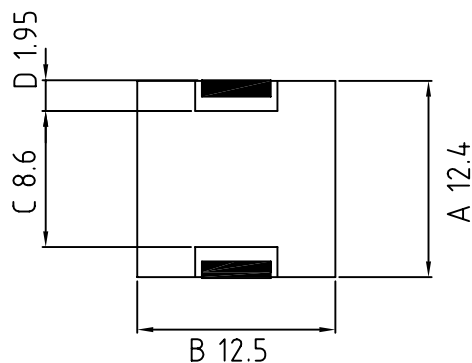




TPI NO.: SMDB0002



FOR CPU POWER INDUCTOR

DATE	REVISED STORY	MODEL : SMD BASE - 2 (TPI NO.: SMDB0002)		
6/01'02	RELEASED THE NEW DRAWING SPEC.	BOBBIN MATERIAL : LCP UL94V-0		
		PIN MATERIAL : PHOSPHORUS BRONZE (TIN PLATED)		
		CLAMP MATERIAL : PHOSPHORUS BRONZE (0.3t)		
		DATE : June 01,2002	REV.: A	TOLERANCE : .XXX $\pm$ 0.08 .XX $\pm$ 0.1 .X $\pm$ 0.2